

AMENDMENTS TO THE SPECIFICATION

Please replace the first paragraph with the following amended paragraph:

This application is a divisional application of U.S. Patent Application Serial No. 09/672,649, filed September 28, 2000, now US Patent No. 6,601,228, which is a continuation of U.S. Patent Application Serial No. 09/010,337, filed January 21, 1998, now US Patent No. 6,209,118, which is related to an application titled "A Programmable Logic Block in an Integrated Circuit, Application Serial No. 09/010,335, filed January 21, 1998, now US Patent No. 6,075,381

On Page 6, replace the paragraph beginning at line 3 with the following amended paragraph:

1.1 Integrated Circuit Connection Circuitry

Busses 60b, 62b, 64b, 72 and the first through third SEL lines 60a, 62a, 64a provide a plurality of internal connections within the ASIC chip that comprises system controller 30 and may be referred to as such. The host bus 22, memory bus 42 and I/O bus 54 provide a plurality of external inputs and outputs for the ASIC chip that comprises the system controller 30. These inputs and outputs may be implemented in the form of leads from the packaging for the chip. The packaging may be a dual-in-line (DIP) package, pin-in-hole package, leadless ceramic package, gull-wing or j-lead package, pin-grid array package, ball grid array, plastic ball grid array or EGA enhanced.